

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|--|---------------------------|------------------|---------|---------------------|
| L1 | 0 | "6030891".pn. | US-PGPUB | OR | ON | 2009/02/21 18:22 |
| L2 | 1 | "6030891".pn. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:22 |
| L4 | 1 | 2 and dielectric\$3 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:23 |
| L6 | 1 | 2 and low same dielectric\$3 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:24 |
| L7 | 1 | "20050045206".pn. | US-PGPUB | OR | ON | 2009/02/21 18:25 |
| L8 | 1 | 7 and low-k | US-PGPUB | OR | ON | 2009/02/21 18:25 |
| L9 | 0 | 7 and sog | US-PGPUB | OR | ON | 2009/02/21 18:29 |
| L10 | 0 | 7 and hsq | US-PGPUB | OR | ON | 2009/02/21 18:30 |
| L11 | 1 | 2 and (pattern\$3 mask\$3) same (trench\$2 via\$1) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:33 |
| L12 | 1 | 2 and solvent | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:39 |
| L13 | 1 | 2 and bak\$3 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:43 |
| L14 | 1 | 2 and metal | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:44 |
| L15 | 1 | 2 and metal same deposit\$4 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:45 |

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|-----|---|---|---------------------------|----|----|---------------------|
| L18 | 1 | 2 and solvent\$1 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:49 |
| L19 | 1 | 7 and component\$1 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:55 |
| L20 | 0 | 7 and (water moisture) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 18:58 |
| L21 | 1 | 2 and (water moiture) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 19:00 |
| L22 | 1 | 2 and (organosilicate\$1 osg methylsilsesquioxane msq fluorine\$1 fluorine-dop\$3 fsg silicon\$1 silicon- dioxide\$2 "sio.sub.2") | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 19:32 |
| L25 | 0 | 2 and (ash\$3 dry) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 19:36 |
| L26 | 1 | 2 and (copper cuprous) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 19:41 |
| L27 | 1 | 2 and (barrier seed) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 20:00 |
| L28 | 0 | 2 and (acetamide DMAC) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 20:12 |
| L29 | 0 | 2 and acid\$2 | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 20:12 |
| L30 | 1 | 7 and plasma | US-PGPUB | OR | ON | 2009/02/21 20:23 |
| L31 | 1 | 2 and (plasma rf photoresist ash\$3) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 20:27 |
| L32 | 0 | 2 and "250" | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/21 21:36 |
| S1 | 1 | "20050045206".pn. | US-PGPUB | OR | ON | 2008/08/15 10:39 |
| S2 | 6 | ("5643407" "20030104320" "20030008518" "6107202" "6417108" "20020058397").pn. | US-PGPUB; USPAT | OR | ON | 2008/08/15 10:41 |

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|-----|---|--|--------------------|----|----|---------------------|
| S3 | 1 | S1 and anneal | US-PGPUB | OR | ON | 2008/08/15 11:14 |
| S4 | 1 | S1 and minutes | US-PGPUB | OR | ON | 2008/08/15 11:39 |
| S5 | 1 | "5643407".pn. | USPAT | OR | ON | 2008/08/15 11:41 |
| S6 | 1 | S5 and (minute\$1 seconds) | USPAT | OR | ON | 2008/08/15 11:42 |
| S7 | 1 | S1 and solvent | US-PGPUB | OR | ON | 2008/08/15 12:17 |
| S8 | 0 | S1 and (moistur\$5 water aqueous) | US-PGPUB | OR | ON | 2008/08/15 12:19 |
| S9 | 1 | S1 and component\$1 | US-PGPUB | OR | ON | 2008/08/15 12:19 |
| S10 | 0 | S1 and (moistur\$5 water aqueous vapor\$7) | US-PGPUB | OR | ON | 2008/08/15 12:23 |
| S11 | 1 | S5 and (moistur\$5 water aqueous vapor\$7) | USPAT | OR | ON | 2008/08/15 12:23 |
| S12 | 1 | "20050045206".pn. | US-PGPUB | OR | ON | 2008/08/21 15:57 |
| S13 | 1 | S12 and clean\$4 | US-PGPUB | OR | ON | 2008/08/21 15:57 |
| S14 | 6 | ("5643407" "20030104320" "20030008518" "6107202" "6417108" "20020058397").pn. | US-PGPUB; USPAT | OR | ON | 2008/08/21 15:58 |
| S15 | 4 | S14 and clean\$4 | US-PGPUB; USPAT | OR | ON | 2008/08/21 15:58 |
| S16 | 0 | S12 and embodi\$5 | US-PGPUB | OR | ON | 2008/08/21 16:52 |

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|-----|------|--|---------------------------|----|----|---------------------|
| S17 | 11 | ("20020058397" "20030008518" "20030104320" "20030194877" "20040060579" "5643407" "5798323" "6100183" "6107202" "6417108" "6713402").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 10:55 |
| S18 | 2194 | pattern\$4 and (trench\$1 via\$1) and "low-k" and (solvent\$1 acid\$1 (dimethyl same acetamide\$1) dmac) and (plasma non-plasma) and (dielectric\$1 osg organosilicate\$1 msq methylsilsesquioxane\$1 fsg fluorine\$3 "silicate glass" sio2 (silicon same dioxide\$1)) | US-PGPUB; USPAT | OR | ON | 2008/08/25 11:08 |
| S19 | 0 | (pattern patterning) and (trench via) and "low-k" and (solvent acid (dimethyl same acetamide) dmac) and (plasma non-plasma) and (dielectric\$1 osg organosilicate msq methylsilsesquioxane fsg fluorine fluoride "silicate glass" sio2 (silicon same dioxide)) | USOCR | OR | ON | 2008/08/25 11:09 |
| S20 | 136 | S18 and "134".clas. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:10 |
| S22 | 96 | S20 and 134/1,1,2,2,3,19,26,16,21,34,35,37.ccls. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:15 |
| S23 | 79 | S22 and photoresist\$1 | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:16 |
| S24 | 79 | S23 and plasma | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:16 |
| S25 | 36 | S24 and (anneal\$4 bak\$4) | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:17 |
| S26 | 0 | S22 and S17 | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:18 |

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| S27 | 11 | pattern\$4 and (trench\$1 via\$1) and "low-k" and (solvent\$1 acid\$1 (dimethyl same acetamide\$1) dmac) and (plasma non-plasma) and (dielectric\$1 osg organosilicate\$1 msq methylsilsesquioxane\$1 fsg fluor\$3 "silicate glass" sic2 (silicon same dioxide\$1)) | FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 11:18 |
| S28 | 47 | S25 S27 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 11:18 |
| S29 | 0 | S28 and S17 | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:22 |
| S30 | 1 | "20050045206".pn. | US-PGPUB | OR | ON | 2008/08/25 11:28 |
| S31 | 1 | S30 and boil\$3 | US-PGPUB | OR | ON | 2008/08/25 11:28 |
| S32 | 3 | S17 and low-k | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:42 |
| S33 | 9 | S17 and dielectric | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:44 |
| S34 | 1 | "5643407".pn. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:47 |
| S35 | 0 | S34 and dielectric same low | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:47 |
| S36 | 0 | S34 and low-k | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:47 |
| S37 | 0 | S34 and capacit\$5 | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 11:58 |
| S38 | 1 | "6100183".pn. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 12:03 |

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| S39 | 1 | S38 and (anneal\$4 bak\$4) | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 12:03 |
| S40 | 47 | S28 and low-k | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 12:16 |
| S41 | 37 | S40 and (anneal\$4 bak\$4) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 12:17 |
| S42 | 11 | ("20020058397" "20030008518" "20030104320" "20030194877" "20040060579" "5643407" "5798323" "6100183" "6107202" "6417108" "6713402").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 14:21 |
| S43 | 2194 | pattern\$4 and (trench\$1 via\$1) and "low-k" and (solvent\$1 acid\$1 (dimethyl same acetamide\$1) dmac) and (plasma non-plasma) and (dielectric\$1 osg organosilicate\$1 msq methylsilsesquioxane\$1 fsg fluori\$3 "silicate glass" siO2 (silicon same dioxide\$1)) | US-PGPUB; USPAT | OR | ON | 2008/08/25 14:22 |
| S44 | 136 | S43 and "134".clas. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 14:22 |
| S45 | 96 | S44 and 134/1,1,2,2,3,19,26,16,21,34,35,37.cds. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 14:22 |
| S46 | 79 | S45 and photoresist\$1 | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 14:22 |
| S47 | 79 | S46 and plasma | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 14:22 |
| S48 | 36 | S47 and (anneal\$4 bak\$4) | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 14:22 |

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| S49 | 11 | pattern\$4 and (trench\$1 via\$1) and "low-k" and (solvent\$1 acid\$1 (dimethyl same acetamide\$1) dmac) and (plasma non-plasma) and (dielectric\$1 osg organosilicate\$1 msq methylsilsesquioxane\$1 fsg fluor\$3 "silicate glass" sic2 (silicon same dioxide\$1)) | FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 14:22 |
| S50 | 47 | S48 S49 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 14:22 |
| S51 | 58 | S42 S50 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 14:24 |
| S52 | 11 | S51 and (wet near3 (clean\$4 strip\$4)) same (dry near3 (clean\$4 strip\$4)) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 14:25 |
| S53 | 2 | "6554912".pn. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 15:34 |
| S54 | 2 | S53 and (h2 hydrogen o2 oxygen inert n2 nitrogen) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 15:35 |

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| S55 | 1 | S53 and plasma same (h2 hydrogen o2 oxygen inert n2 nitrogen) | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 15:36 |
| S56 | 2 | "5643407".pn. | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 15:49 |
| S57 | 4 | S53 S56 | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 15:49 |
| S58 | 2 | S57 and (copper cu) | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 15:49 |
| S59 | 3 | S57 and deposit\$4 | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 15:52 |
| S60 | 27 | S51 and (copper cu cuprous) same deposit\$4 | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 16:07 |

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| S61 | 11 | S60 and (copper cu cuprous) near3 deposit\$4 | US-PGPUB; USPAT; USOCR; FPRS; EPC; JPO; DERWENT | OR | ON | 2008/08/25 16:08 |
| S62 | 2 | S67 and (dielectric\$1 osg organosilicate\$1 msq methylsilsesquioxane\$1 fsg fluori\$3 "silicate glass" sio2 (silicon same dioxide\$1)) | US-PGPUB; USPAT | OR | ON | 2008/08/25 16:29 |
| S63 | 1 | S67 and (dmac (dimethyl same acetamide\$1)) | US-PGPUB; USPAT | OR | ON | 2008/08/25 16:57 |
| S64 | 1 | S67 and acid\$2 | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:00 |
| S65 | 1 | S67 and (critical dimension\$1 extru\$5) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:21 |
| S66 | 36 | S47 and (anneal\$4 bak\$4) | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 17:22 |
| S67 | 1 | S47 and ((critical same dimension\$1) extru\$5) | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 17:23 |
| S68 | 1 | S67 and ((critical same dimension\$1) extru\$5) same (anneal\$4 bak\$3) | US-PGPUB; USPAT; USOCR | OR | ON | 2008/08/25 17:26 |
| S69 | 69 | wafer\$1 and ((critical same dimension\$1) (metal\$3 same extru\$5)) same (anneal\$4 bak\$3) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:27 |
| S70 | 820 | wafer\$1 and ((critical same dimension\$1) (metal\$3 same extru\$5)) same (anneal\$4 bak\$3) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:28 |
| S71 | 322 | S70 and wafer\$1 same ((critical same dimension \$1) (metal\$3 same extru\$5)) same (anneal\$4 bak \$3) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:28 |
| S72 | 1 | S71 and wafer\$1 same ((critical same dimension \$1) and (metal\$3 same extru\$5)) same (anneal\$4 bak\$3) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:28 |

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|-----|----|--|---|----|----|---------------------|
| S73 | 1 | S71 and wafer\$1 and ((critical same dimension\$1) and (metal\$3 same extru\$5)) same (anneal\$4 bak \$3) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:28 |
| S74 | 8 | ((critical same dimension\$1) and (metal\$3 same extru\$5)) same (anneal\$4 bak\$3) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:29 |
| S75 | 2 | "6417108".pn. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2008/08/25 17:42 |
| S76 | 0 | S75 and (dmac (dimethyl same acetamide\$1)) | US-PGPUB; USPAT | OR | ON | 2008/08/25 17:47 |
| S77 | 12 | ("20020058397" "20030008518" "20030104320" "20030194877" "20040060579" "5643407" "5798323" "6100183" "6107202" "6417108" "6554912" "6713402").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:40 |
| S78 | 1 | "20050045206".pn. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:43 |
| S79 | 2 | ("2005/0045206").URPN. | USPAT | OR | ON | 2009/02/20 14:44 |
| S80 | 15 | ("5705435" "5723383" "5741626" "5773201" "5877075" "6251771" "6277733" "6323121" "6342446").PN. OR ("6713402").URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:46 |
| S81 | 16 | ("20020013239" "3979241" "4230523" "5320709" "5571447" "5792274" "5905063" "5972862" "6068000" "6350560" "6475966"). PN. OR ("6554912").URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:46 |
| S82 | 14 | ("5152857" "5340435" "5371037" "5374564" "5668045" "5937312" "5952694" "6090688" "6110391").PN. OR ("6417108").URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:46 |

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|-----|----|--|---|----|----|---------------------|
| S83 | 16 | ("3988256" "4067100" "4165294" "4567132" "4786578" "4824762" "5201960" "5362608" "5688618" "5904156" "6000411" "6002202"). PN. OR ("6107202").URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:46 |
| S84 | 9 | ("5932487").PN. OR ("6100183").URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:46 |
| S85 | 52 | ("4395348" "4617251" "4732695" "4770713" "4824763" "4904571" "5174816" "5279771" "5308745" "5334332" "5417877" "5472830" "5496491" "5507978" "5545353" "5563119" "5567574" "5571447" "5597678" "5648324" "5665688" "5709737").PN. OR ("5798323"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:46 |
| S86 | 31 | ("5003062" "5219792" "5266525" "5320983" "5334332" "5393702").PN. OR ("5643407"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:47 |
| S87 | 11 | pattern\$4 and (trench\$1 via\$1) and "low-k" and (solvent\$1 acid\$1 (dimethyl same acetamide\$1) dmac) and (plasma non-plasma) and (dielectric\$1 osg organosilicate\$1 msq methylsilsesquioxane\$1 fsg fluori\$3 "silicate glass" sio2 (silicon same dioxide\$1)) | FPRS; EPO; JPO; DERWENT | OR | ON | 2009/02/20 14:49 |
| S88 | 86 | (S77 S80 S81 S82 S83 S84 S85 S86 S87) and (anneal\$4 bak\$3) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2009/02/20 14:50 |
| S89 | 84 | S88 and (minute\$ seconds) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2009/02/20 14:50 |
| S90 | 1 | S89 | FPRS; EPO; JPO; DERWENT | OR | ON | 2009/02/20 14:51 |

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| S91 | 1 | S78 and (furnace hot-plate plate) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 14:55 |
| S92 | 1 | "6603204".pn. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 15:00 |
| S93 | 1 | "20020117760".pn. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 15:00 |
| S94 | 1 | S93 and seconds | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 15:01 |
| S95 | 84 | S88 and (minute\$1 seconds) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT | OR | ON | 2009/02/20 15:23 |
| S96 | 1 | S95 and (minute\$1 seconds) | FPRS; EPO; JPO; DERWENT | OR | ON | 2009/02/20 15:23 |
| S97 | 61 | S88 and (minute\$ seconds) same (bak\$3 anneal \$4) | US-PGPUB; USPAT | OR | ON | 2009/02/20 15:32 |
| S98 | 1 | "6030891".pn. | US-PGPUB; USPAT | OR | ON | 2009/02/20 15:43 |
| S99 | 1 | S98 and (hot-plate hotplate plate furnace asher) | US-PGPUB; USPAT | OR | ON | 2009/02/20 15:44 |
| S100 | 1 | S98 and plasma | US-PGPUB; USPAT | OR | ON | 2009/02/20 15:48 |
| S101 | 1 | S98 and ((anneal\$4 bak\$4) plasma) | US-PGPUB; USPAT | OR | ON | 2009/02/20 15:50 |
| S102 | 1 | "5952694".pn. and plasma | US-PGPUB; USPAT | OR | ON | 2009/02/20 15:57 |
| S103 | 1 | "5003062".pn. and plasma | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:08 |
| S104 | 0 | "4617251".pn. and plasma | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:11 |

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|------|---|---|---------------------------|----|----|---------------------|
| S105 | 1 | S78 and celsius | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 16:12 |
| S106 | 0 | S88 | USOCR | OR | ON | 2009/02/20 16:16 |
| S107 | 1 | S78 and temperature | US-PGPUB; USPAT; USOCR | OR | ON | 2009/02/20 16:20 |
| S108 | 2 | S98 S103 | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:21 |
| S109 | 1 | S108 and (furnace ash\$3) | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:22 |
| S110 | 2 | S108 and plasma | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:22 |
| S111 | 2 | S108 and (vacuum pressure torr atmosphere\$1 atm pa kpa) | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:25 |
| S112 | 2 | S108 and (vacuum pressure torr atmosphere\$1 atm pa kpa anneal\$4 bak\$4 plasma) | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:27 |
| S113 | 2 | S108 and (plate hotplate hot-plate furnace ash\$3) | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:38 |
| S114 | 1 | S108 and wet same solvent\$1 | US-PGPUB; USPAT | OR | ON | 2009/02/20 16:42 |

2/21/2009 10:01:29 PM

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